

# Single N-channel MOSFET with schottky diode

ELM16706EA-S

## ■ General description

ELM16706EA-S uses advanced trench technology to provide excellent Rds(on) and low gate charge.

## ■ Features

- Vds=30V
- Id=3.3A (Vgs=10V)
- Rds(on) < 65mΩ (Vgs=10V)
- Rds(on) < 75mΩ (Vgs=4.5V)
- Rds(on) < 160mΩ (Vgs=2.5V)
- Schottky diode
- Vds(V)=20V
- If=1A
- Vf < 0.5V@0.5A

## ■ Maximum absolute ratings

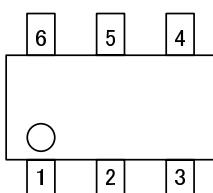
Parameter	Symbol	MOSFET	Schottky	Unit	Note
Drain-source voltage	Vds	30		V	
Gate-source voltage	Vgs	±12		V	
Continuous drain current	Ta=25°C	Id	3.3	A	1
	Ta=70°C		2.6		
Pulsed drain current	Idm	10		A	2
Schottky reverse voltage	Vka		20	V	
Continuous forward current	Ta=25°C	If	2	A	1
	Ta=70°C		1		
Pulsed forward current	Ifm		10	A	2
Power dissipation	Ta=25°C	Pd	1.15	W	
	Ta=70°C		0.70		
Junction and storage temperature range	Tj, Tstg	-55 to 150	-55 to 150	°C	

## ■ Thermal characteristics

Parameter (MOSFET)		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	Rθja	80.3	110.0	°C/W	1
Maximum junction-to-ambient	Steady-state		117.0	150.0	°C/W	
Maximum junction-to-lead	Steady-state	Rθjl	43.0	80.0	°C/W	3
Parameter (Schottky)		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	Rθja	109.4	135.0	°C/W	1
Maximum junction-to-ambient	Steady-state		136.5	175.0	°C/W	
Maximum junction-to-lead	Steady-state	Rθjl	58.5	80.0	°C/W	3

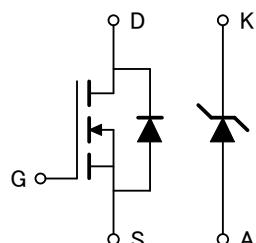
## ■ Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	ANODE
2	SOURCE
3	GATE
4	DRAIN
5	No Connection
6	CATHODE

## ■ Circuit



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### ■ Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	30			V
Zero gate voltage drain current	Idss	Vds=24V			1	μ A
		Vgs=0V	Tj=55°C		5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±12V			100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μ A	1.0	1.4	1.8	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	10			A
Static drain-source on-resistance	Rds(on)	Vgs=10V		44	65	m Ω
		Id=3.3A	Tj=125°C	64	90	
		Vgs=4.5V, Id=3.0A		53	75	m Ω
		Vgs=2.5V, Id=1A		106	160	m Ω
Forward transconductance	Gfs	Vds=5V, Id=3.3A		11.7		S
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.81	1.00	V
Max. body-diode continuous current	Is				2.5	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz		226	270	pF
Output capacitance	Coss			39		pF
Reverse transfer capacitance	Crss			29		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		1.4	1.7	Ω
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Qg	Vgs=4.5V, Vds=15V, Id=3.3A		3.00	3.60	nC
Gate-source charge	Qgs			1.40		nC
Gate-drain charge	Qgd			0.55		nC
Turn-on delay time	td(on)	Vgs=10V, Vds=15V Rl=4.7 Ω, Rgen=6 Ω		2.6		ns
Turn-on rise time	tr			3.2		ns
Turn-off delay time	td(off)			14.5		ns
Turn-off fall time	tf			2.1		ns
Body diode reverse recovery time	trr	If=3.3A, dl/dt=100A/μ s		10.2	13.0	ns
Body diode reverse recovery charge	Qrr	If=3.3A, dl/dt=100A/μ s		3.8		nC
<b>SCHOTTKY PARAMETERS</b>						
Forward voltage drop	Vf	If=0.5A		0.39	0.50	V
Max. reverse leakage current	Irm	Vr=16V			0.10	
		Vr=16V, Tj=125°C			20.00	mA
Junction capacitance	Ct	Vr=10V		34		pF
Schottky reverse recovery time	trr	If=1A, dl/dt=100A/μ s		5.2	10.0	ns
Schottky reverse recovery charge	Qrr	If=1A, dl/dt=100A/μ s		0.8		nC

### NOTE :

- The value of Rθja is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The Rθja is the sum of the thermal impedance from junction to lead Rθjl and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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## ■ Typical electrical and thermal characteristics

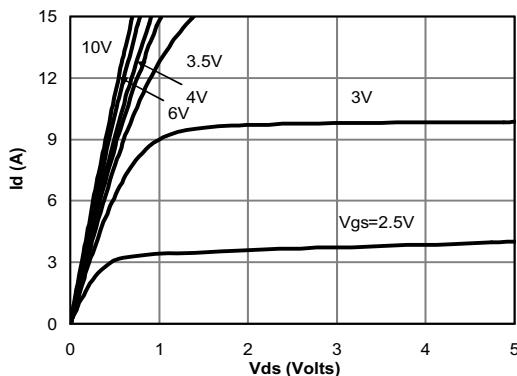


Fig 1: On-Region Characteristics

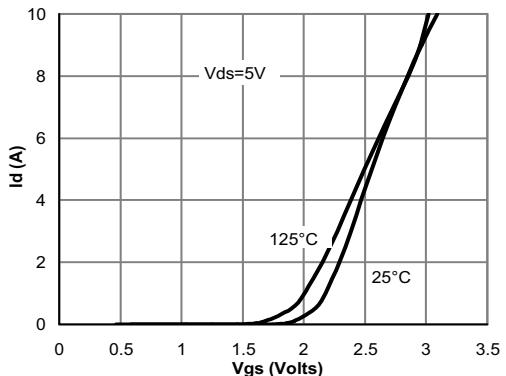


Figure 2: Transfer Characteristics

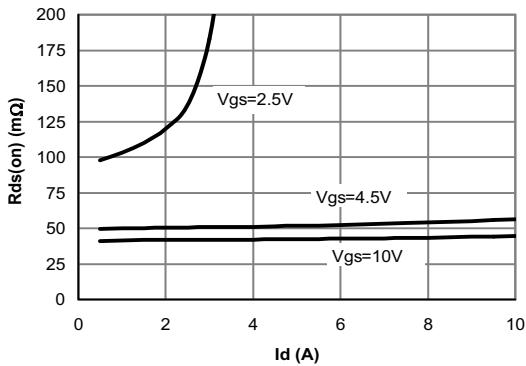


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

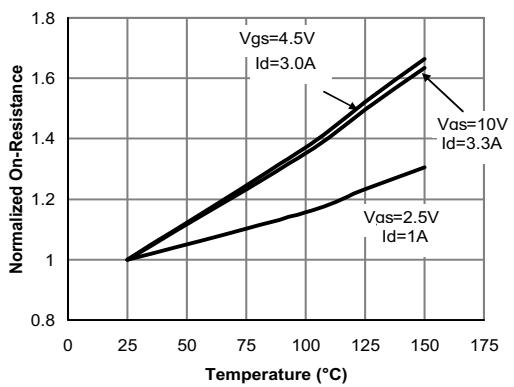


Figure 4: On-Resistance vs. Junction Temperature

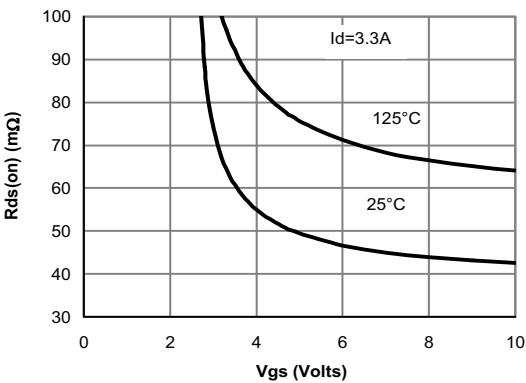


Figure 5: On-Resistance vs. Gate-Source Voltage

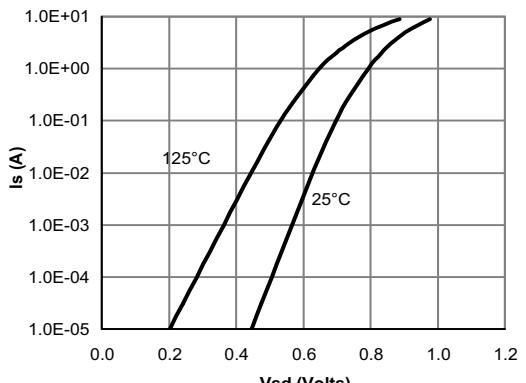
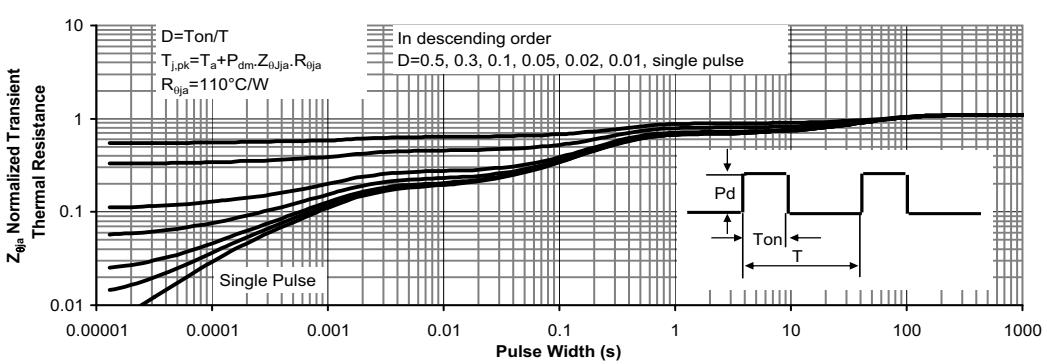
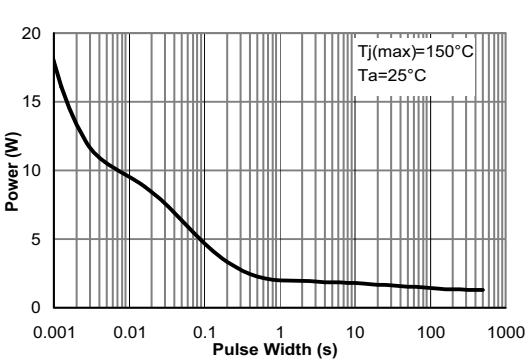
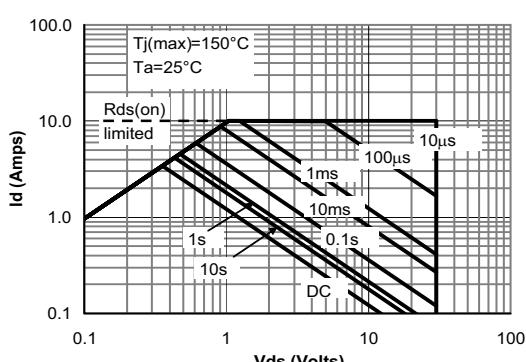
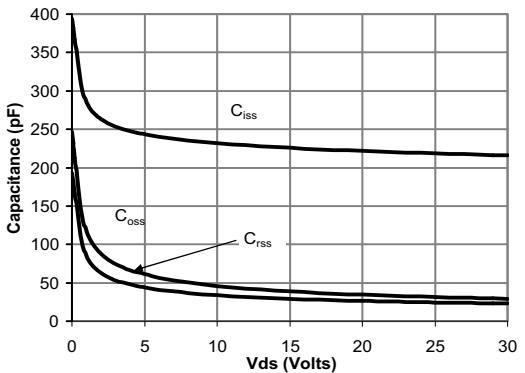
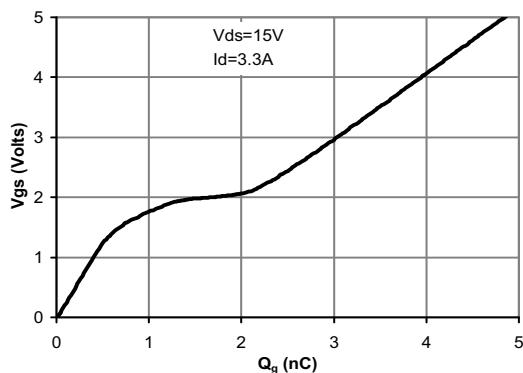


Figure 6: Body-Diode Characteristics

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## ■ Typical electrical and thermal characteristics (Schottky)

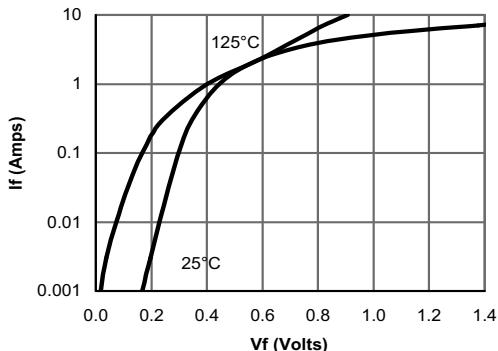


Figure 12: Schottky Forward Characteristics

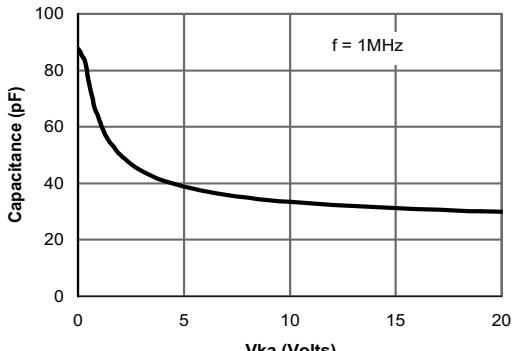


Figure 13: Schottky Capacitance Characteristics

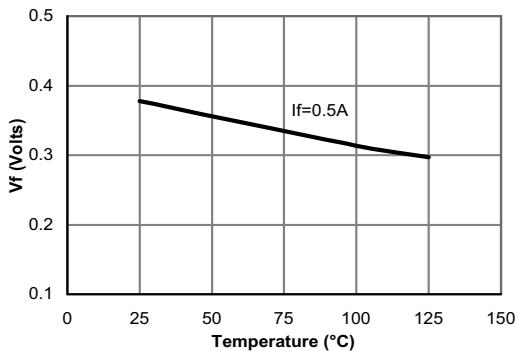


Figure 14: Schottky Forward Drop vs. Junction Temperature

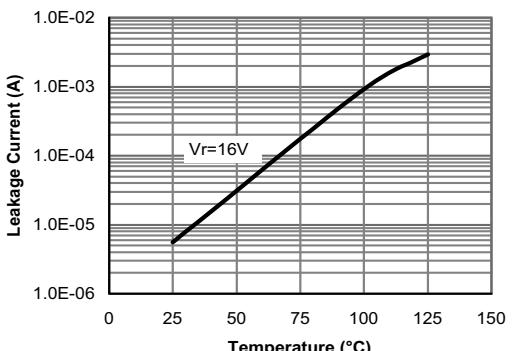


Figure 15: Schottky Leakage current vs. Junction Temperature

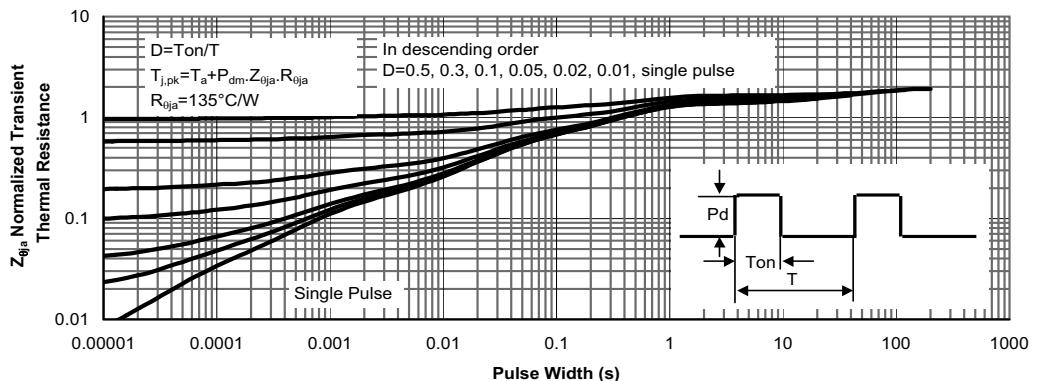


Figure 15: Schottky Normalized Maximum Transient Thermal Impedance